

# Service Manual Level 1-2 for **BenQ** mobile **S81**



Release	Date	Department	Notes to change
R 1.0	31.08.2006	ISC S CES	New document

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 1 of 37

## Table of Content

<b>1. Key Feature .....</b>	<b>3</b>
<b>2. Spare Part Overview of S81 .....</b>	<b>4</b>
<b>3. Disassembly of S81 .....</b>	<b>6</b>
<b>5 Assembly of S81 .....</b>	<b>13</b>
<b>6 BenQ Service Equipment User Manual.....</b>	<b>20</b>
<b>7 Setup of the Software .....</b>	<b>21</b>
<b>8 Software basic settings.....</b>	<b>22</b>
<b>4. Software Download procedure .....</b>	<b>23</b>
<b>5. Download PPF (Handset configuration) .....</b>	<b>25</b>
<b>6. Backup and Restore of Wap and Network Setting .....</b>	<b>27</b>
<b>7. Backup and Restore of Media Center content .....</b>	<b>28</b>
<b>8. Unlock Tool .....</b>	<b>29</b>
<b>14 International Mobile Equipment Identity, IMEI .....</b>	<b>31</b>
<b>15 General Testing Information.....</b>	<b>32</b>

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 2 of 37

## 1. Key Feature

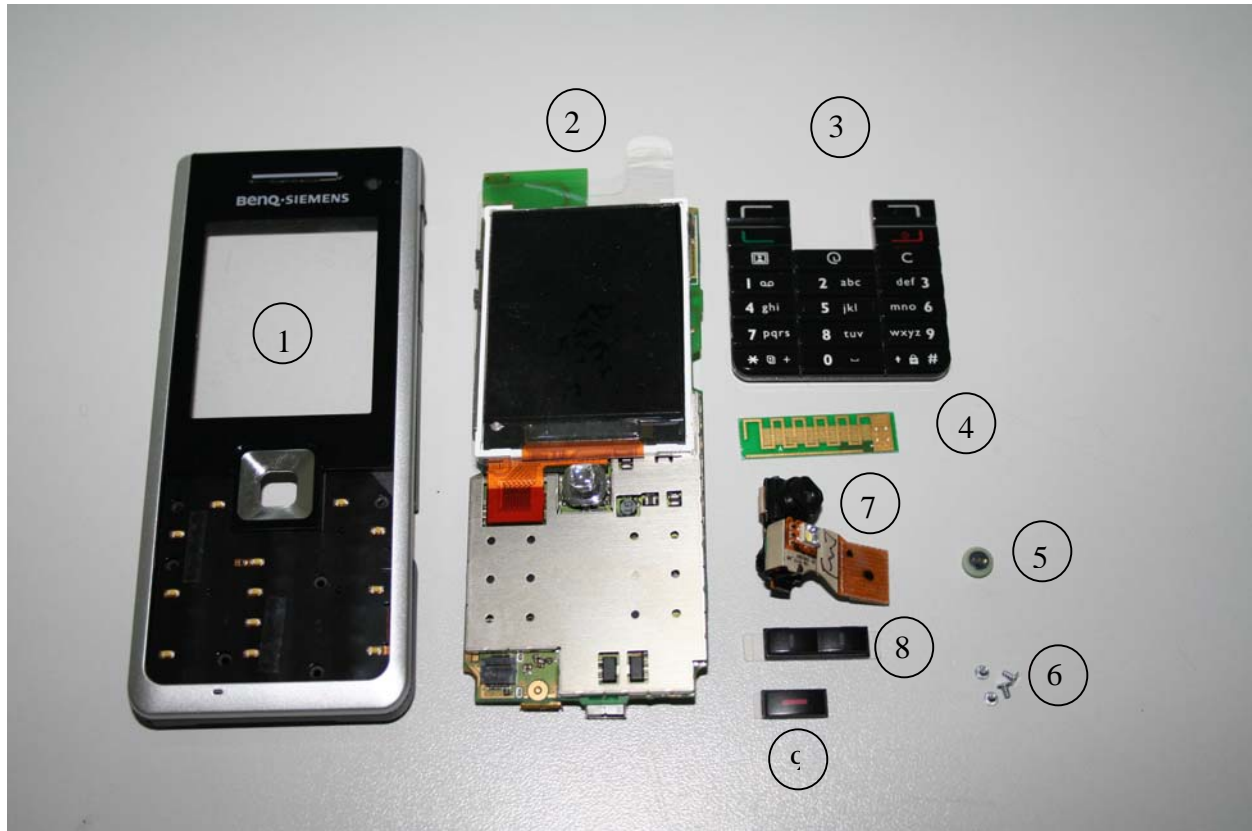
<b>Frequency</b>	<ul style="list-style-type: none"> <li>• Tri-band GSM/GPRS 900/1800/1900, GPRS Class 10</li> </ul>
<b>Antenna</b>	<ul style="list-style-type: none"> <li>• Internal Antenna</li> </ul>
<b>Display</b>	<ul style="list-style-type: none"> <li>• 1.8" ; 128* 160 pixel; Type: 262K TFT</li> </ul>
<b>Embedded DSC</b>	<ul style="list-style-type: none"> <li>• 300K pixel DSCM</li> </ul>
<b>Memory</b>	<ul style="list-style-type: none"> <li>• Flash 128MB + Pseudo SRAM:32MB</li> </ul>
<b>External Memory</b>	<ul style="list-style-type: none"> <li>• Mini SD Card</li> </ul>
<b>Entertainment Feature</b>	<ul style="list-style-type: none"> <li>• MP3 / AAC / AAC+ player</li> <li>• 2 default C code game</li> </ul>
<b>Connectivity</b>	<ul style="list-style-type: none"> <li>• USB supported</li> </ul>
<b>Battery</b>	<ul style="list-style-type: none"> <li>• Lithium-Ion 920 mAh</li> </ul>
<b>Handsfree</b>	<ul style="list-style-type: none"> <li>• Stereo type with fashionable design</li> </ul>
<b>Keys</b>	<ul style="list-style-type: none"> <li>• 27 keys (5-way Navigation key, 1 OK key, 12 number keys, 2 soft-keys, 2 send/end keys, 5 top keys (MP3 play/pause key, 2 for FF/REW, 2 for volume))</li> </ul>
<b>Message Service</b>	<ul style="list-style-type: none"> <li>• MMS/EMS/SMS</li> </ul>
<b>Ring Tone</b>	<ul style="list-style-type: none"> <li>• MP3 / AAC / AAC+ / Midi / I-Melody ring tone</li> </ul>
<b>MP3 – Player</b>	<ul style="list-style-type: none"> <li>• Support MP3/AAC</li> <li>• Equalizer</li> </ul>



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 3 of 37

## 2. Spare Part Overview of S81

### Overview Upper Parts



No.	Description CM	Order Number
1.	Upper Case Shell	Tbd.
2.	RF Control Board	Tbd.
3.	Keypad	L50658-A222-A8
4.	Antenna	L50658-A122-C80
5.	Microphone	L50654-Z6-C146
6.	Lift Screws	L50658-A220-A32
7.	Camera Module	L50651-Z1508-A214
8.	Side Key Right	Tbd.
9.	Side Key Left	Tbd.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 4 of 37

## Overview Lower Parts



No.	Description CM	Order Number
10.	Lower Case Shell	L50658-A222-A11
11.	Battery Cover	L50658-A222-A12
12.	Battery	L50645-K1310-X499
13.	Screw Caps	L50658-A222-A18
14.	Base Screws	L50658-A220-A32
15.	Vibra Alert	Tbd.
16.	Screw Caps	Tbd.
17.	SIM Card Holder	Tbd.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 5 of 37

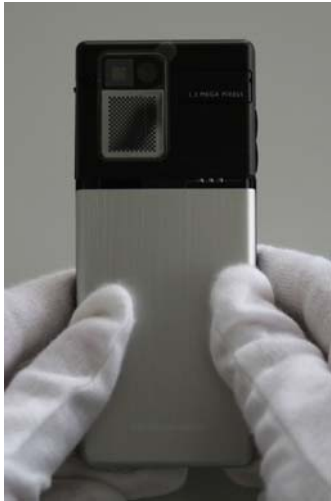
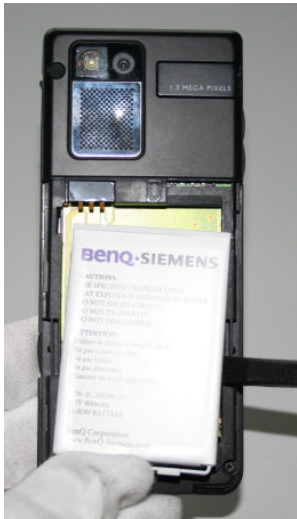
### 3. Disassembly of S81

All repairs as well as disassembling and assembling have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.




For more details please check information in c – market

<https://market.benqmobile.com/SO/welcome.lookup.asp>

There you can find the document “ESD Guideline”.

<p><b>Step 1</b></p> 	<p>Remove Battery Cover.</p>
<p><b>Step 2</b></p> 	<p>Remove Battery</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 6 of 37</p>

<p><b>Step 3</b></p> 	
<p><b>Step 4</b></p> 	<p>Remove Screw Cap by using Tweezers.</p>
<p><b>Step 5</b></p> 	<p>Remove Screw Cap by using Tweezers</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 7 of 37</p>

**Step 6**



Remove Screws by using the Torque – Screwdriver. T5+.

**Step 7**



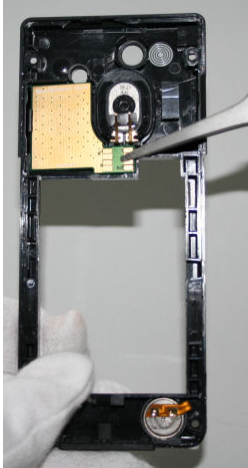
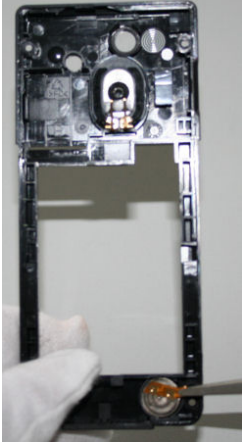

Remove Lower Case Shell by using the Alternative Opening Tool.

**Step 8**



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 8 of 37



<p><b>Step 9</b></p> 	<p>Remove SIM Card Holder by using Tweezers.</p>
<p><b>Step 10</b></p> 	<p>Remove Vibra Alert by using Tweezers.!!!</p>
<p><b>Step 11</b></p> 	<p>Remove Camera Flex Cable by using Tweezers.</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 9 of 37</p>

**Step 12**



Remove RF Control Board with care.

**Step 13**



It is mandatory to place a Protection Foil onto the Display to avoid scratches.

**Step 14**



Remove Antenna by using Tweezers.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 10 of 37

**Step 15**



Remove Side Key Right by using Tweezers.

**Step 16**





Remove Side Key Left by using Tweezers.

**Step 17**






Remove Camera Module very carefully.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 11 of 37




<p><b>Step 18</b></p> 	<p>Remove Microphone by using Tweezers.</p>
<p><b>Step 19</b></p> 	<p>Remove Lift Screws by using the PZ0 cross screwdriver.</p>
<p><b>Step 20</b></p> 	<p>Remove Keypad by using Tweezers.</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 12 of 37</p>




## 5 Assembly of S81

<p><b>Step 1</b></p> 	<p>Assemble Keypad.</p>
<p><b>Step 2</b></p> 	<p>Place Lift Screws by using the PZ0 cross screwdriver.</p>
<p><b>Step 3</b></p> 	<p>Assemble Camera Module very carefully.</p>


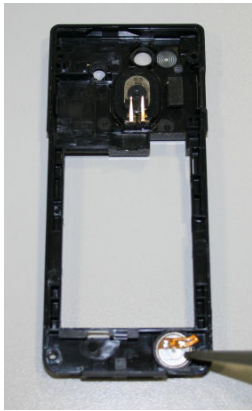

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 13 of 37</p>

<p><b>Step 4</b></p> 	<p>Assemble the Microphone by using Tweezers.</p>
<p><b>Step 5</b></p> 	<p>Remove Display Foil.</p>
<p><b>Step 6</b></p> 	<p>Place RF control board into upper case</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 14 of 37</p>

<p><b>Step 7</b></p> 	<p>Assemble Camera Flex Cable.</p>
<p><b>Step 8</b></p> 	<p>Assemble Antenna by using Tweezers.</p>
<p><b>Step 9</b></p> 	<p>Assemble the Side Key Left by using Tweezers.</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 15 of 37</p>

<p><b>Step 10</b></p> 	<p>Assemble the Side Key Right by using Tweezers.</p>
<p><b>Step 11</b></p> 	<p>Assemble Vibra Alert by using Tweezers into lower case shell.</p>
<p><b>Step 12</b></p> 	<p>Assemble SIM Card Holder by using Tweezers.</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 16 of 37</p>



**Step 13**



Assemble the Lower Case Shell and RF Control Board.

**Step 14**






Place Screws.

**Step 15**



Assemble Screw Cover .

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 17 of 37

<p><b>Step 16</b></p> 	<p>Assemble Screw Cover.</p>
<p><b>Step 17</b></p> 	<p>Assemble Battery .</p>
<p><b>Step 18</b></p> 	<p>Assemble Battery Cover.</p>

<p>Technical Documentation</p>	<p>Release 1.0</p>
<p>TD_Repair_L1-L2_S81_R1.0.pdf</p>	<p>Page 18 of 37</p>

**Step 19**



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 19 of 37





## 6 BenQ Service Equipment User Manual

### Introduction

Every LSO repairing BenQ handset must ensure that the quality standards are observed. BenQ has developed an automatic testing system that will perform all necessary measurements. This testing system is known as:

### BenQ Mobile Service Equipment

- For disassembling / assembling

	<p><b>Torque – Screwdriver</b> Part Number: F 30032 – P 228 – A1</p>
	<p><b>Opening tool</b> (Case opening without destroying) Part Number: F 30032 – P 38 – A1</p>
	<p><b>Alternative Opening tool</b> Part Number: F30032 – P583 – A1</p>
	<p><b>Tweezers</b></p>

- For testing

**All mobile phones have to be tested with the GRT – Software. The service partner is responsible to ensure that all required hardware is available.**

For additional Software and Hardware options as well as the supported GRT equipment, please check the GRT User manual.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 20 of 37

## 7 Setup of the Software

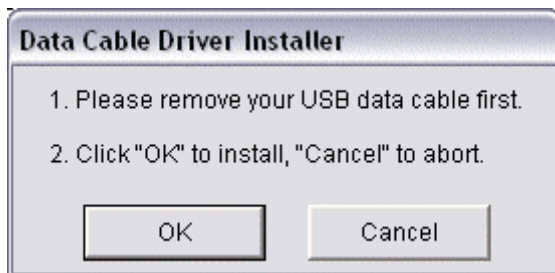
Download of the required software:

Download the driver, the XCSO software mobile software (core-software and language files) from the Technical Support Page:

**<https://market.benqmobile.com/so/welcome.lookup.asp>**

Installation of USB – Serial converter boot cable:

Start the “DataCableDrvInstaller.exe” file and follow the instructions of the installer.



Plug in the Data cable and follow the installation instructions to complete the process.

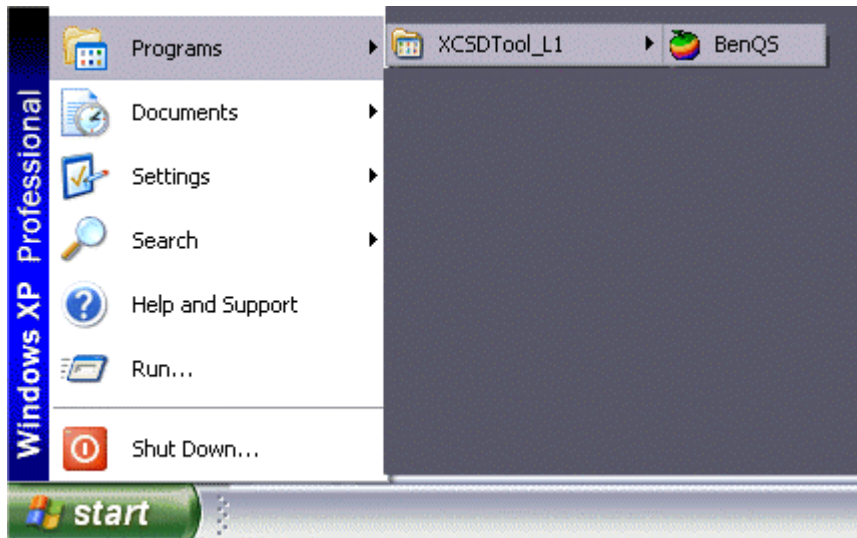
**Check the Comport number of the data cable in the device manager.  
(XCSO tool supports only Comport 1 to 10)**

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 21 of 37

Installation of XCSD tool:

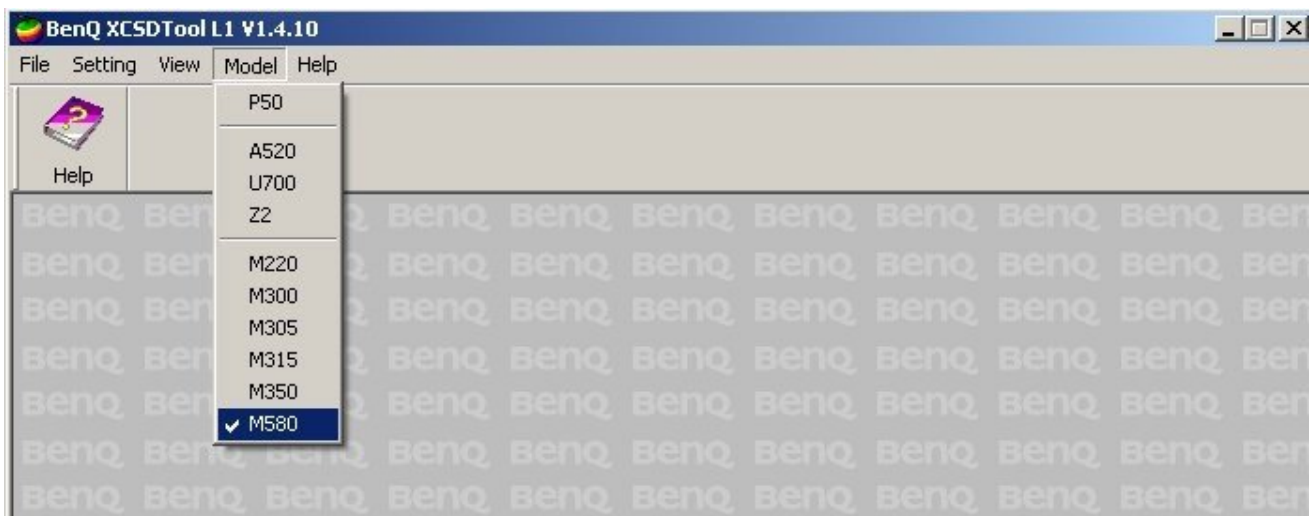
Start “setup.exe” file and follow the instructions.

The installer creates a shortcut in the start menu bar. Start – Programs – XCSDTool\_L1 - BenQS



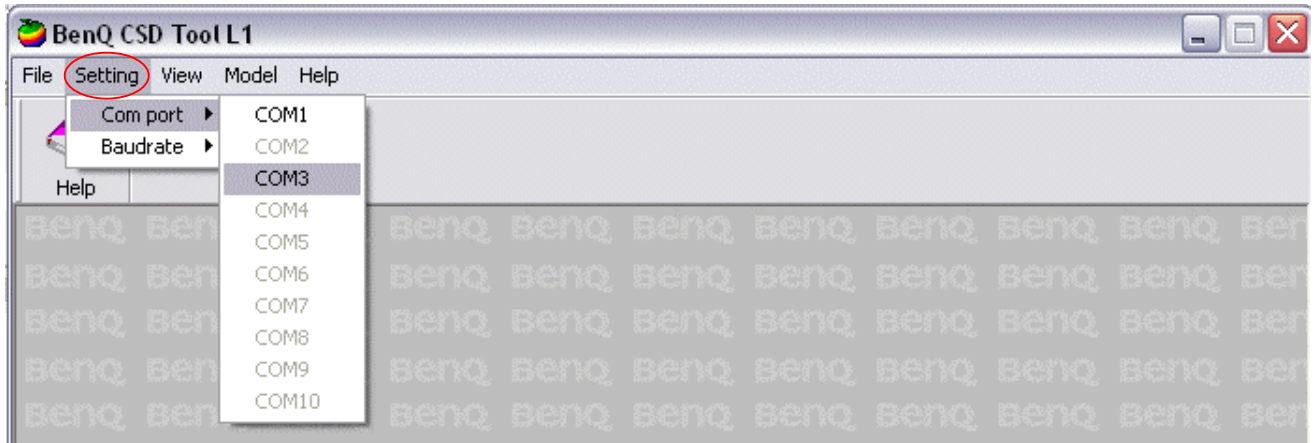
## 8 Software basic settings

- Start the software (BenQS.exe). The XCSD tool will be shown on the screen
- Select Model (for example see the screenshot below):



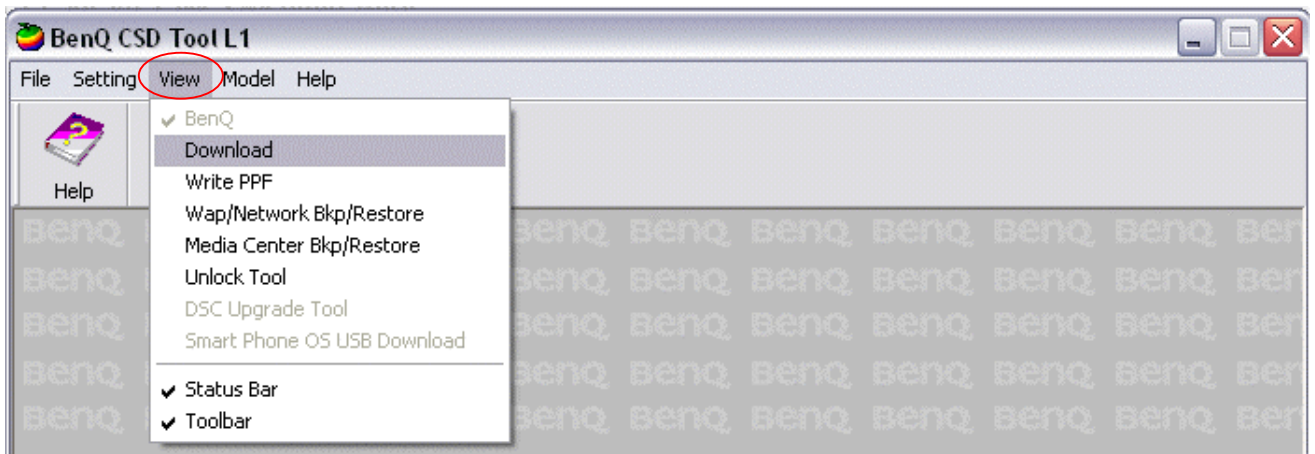
Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 22 of 37

- Select Com port (Setting – Com port):



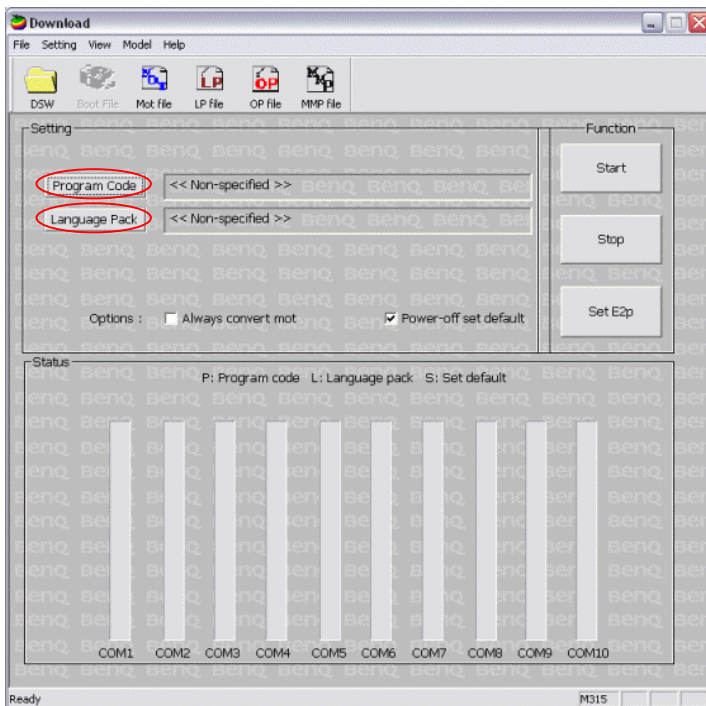
## 4. Software Download procedure

- Select Download Option (View – Download):



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 23 of 37

- Select Program Code Language Pack (example: E22 1 11710.mot) and (example E22 L 11711.mot)



Status bar colour scheme:  
 yellow waiting for update  
 blue update in progress  
 red error occurred  
 black Comport not available  
 green Update successful

- Connect mobile phone with data cable. Phone must be switched off. Click on “Start” button and press the power on button on the handset to start the download. During download process status bar shows the state of the process of P = Program code, L = Language file and S = Set default (if activated). After successful SW download, the status bar of the used Com port is changed to green.

Erase of customer data:

Select the “Power-off set default” option to erase all customer data of the phone during the download process.

- Click the “Set E2p” to erase the customer data without software update.

SW files naming rules:

Program Code E22111710  
 Language Pack E22L11711

E22 Project name  
 117 Program Code  
 L Language Pack  
 117 Version 1.17  
 10/11 Program Code ID

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 24 of 37

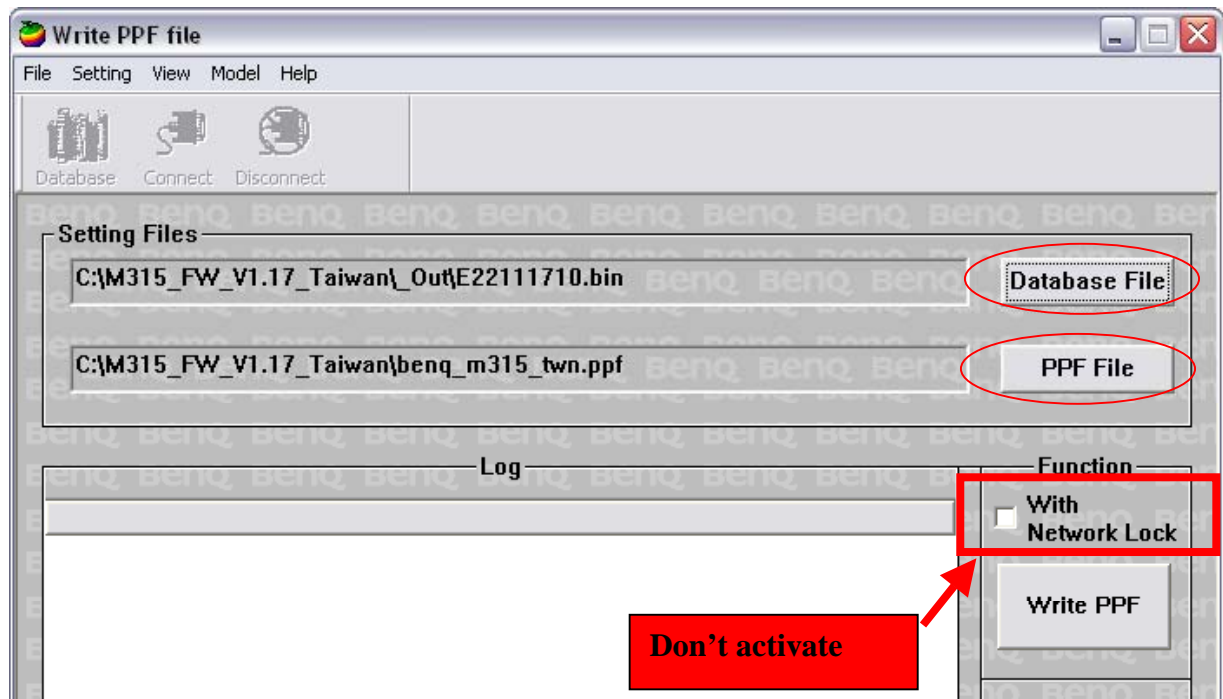


## 5. Download PPF (Handset configuration)

- Select write PPF option (View – Write PPF):



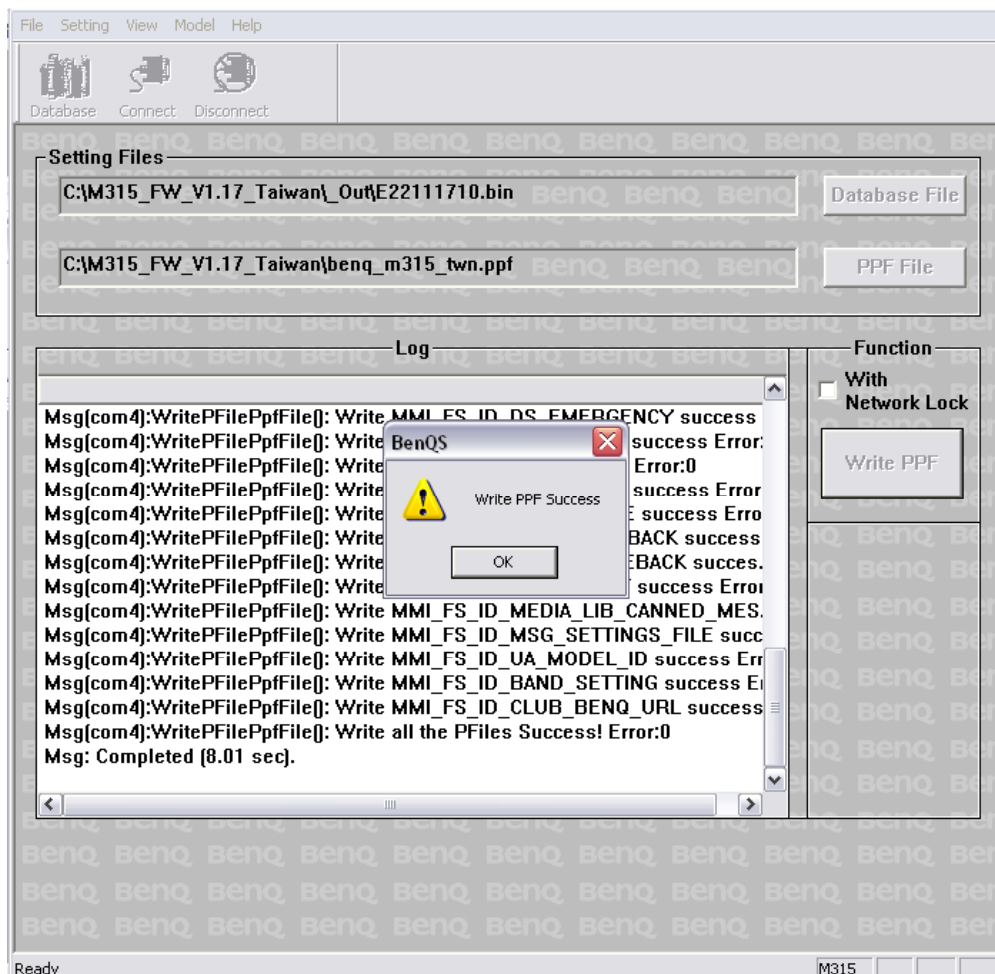
- Select  (example: E22111710.bin) and  (example benq\_m315\_twn.ppf)



- Connect mobile phone with data cable. Phone must be switched on. Click to “Write PPF” button to start the process.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 25 of 37

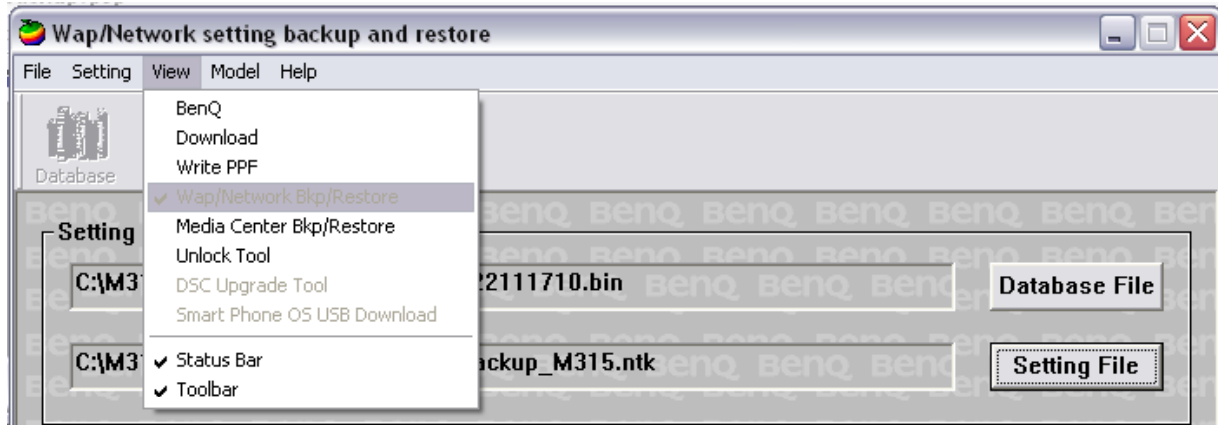
- Confirmation about successful write of PPF appears after process is completed.



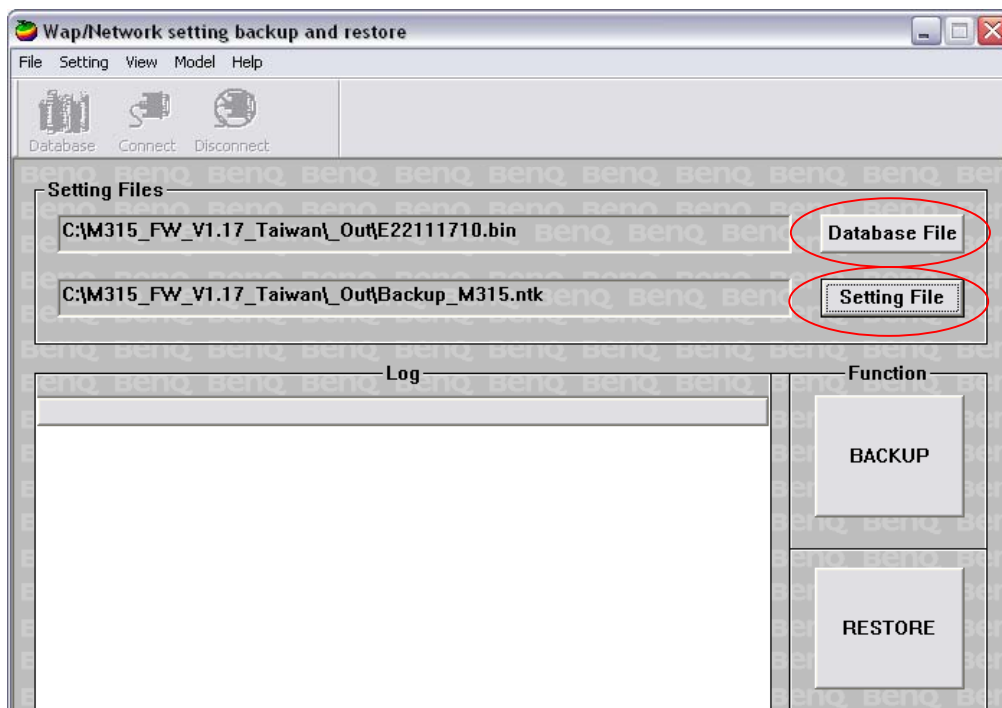
Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 26 of 37

## 6. Backup and Restore of Wap and Network Setting

- Select Back and Restore of Wap and Network Settings option (View – Wap/Network Bkp/Restore):



- Select Database File (example: E22111710.bin) and
- Setting File (create new txt file and rename it to ntk file for settings backup)

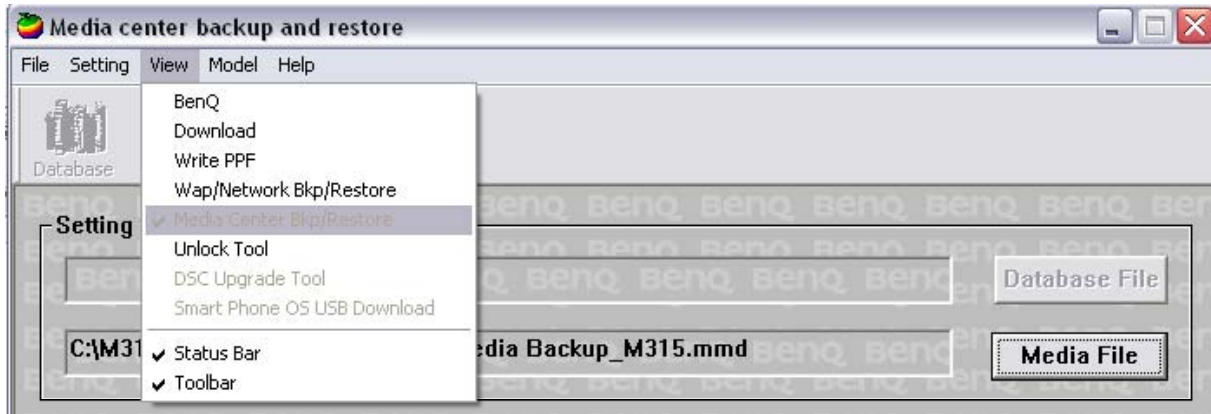


- Connect mobile phone with data cable. Phone must be switched off.
- Click to “Backup” button to start the transfer the settings into the selected file.
- Click to “Restore” button to start the transfer from selected file into handset.

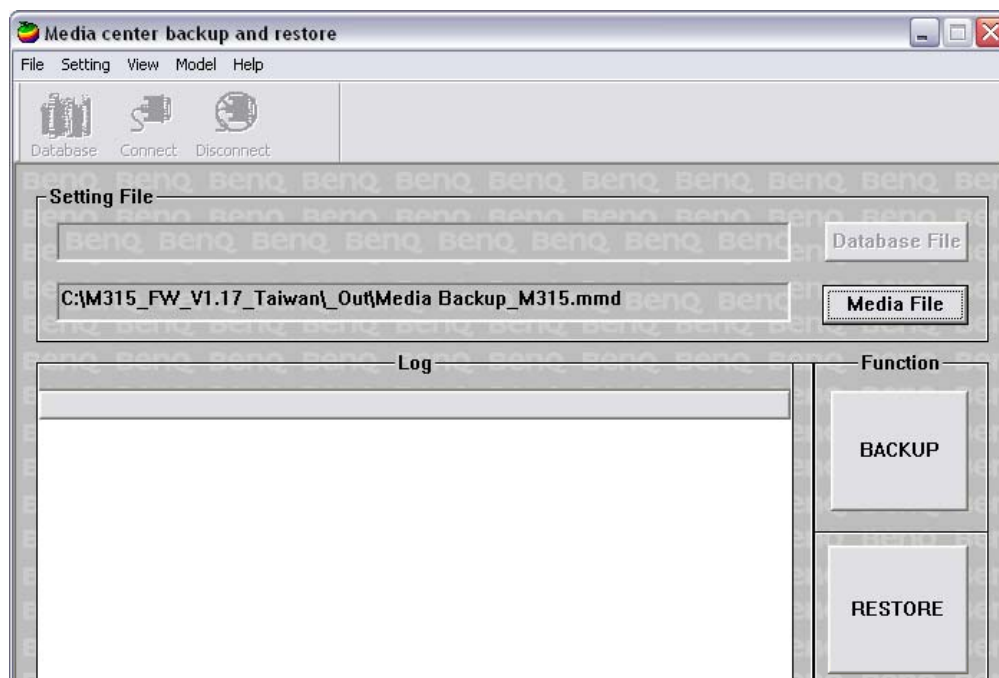
Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 27 of 37

## 7. Backup and Restore of Media Center content

- Select Back and Restore of Media center (View – Media center Bkp/Restore):



- Select Media File (create new txt file and rename it to mmd file)

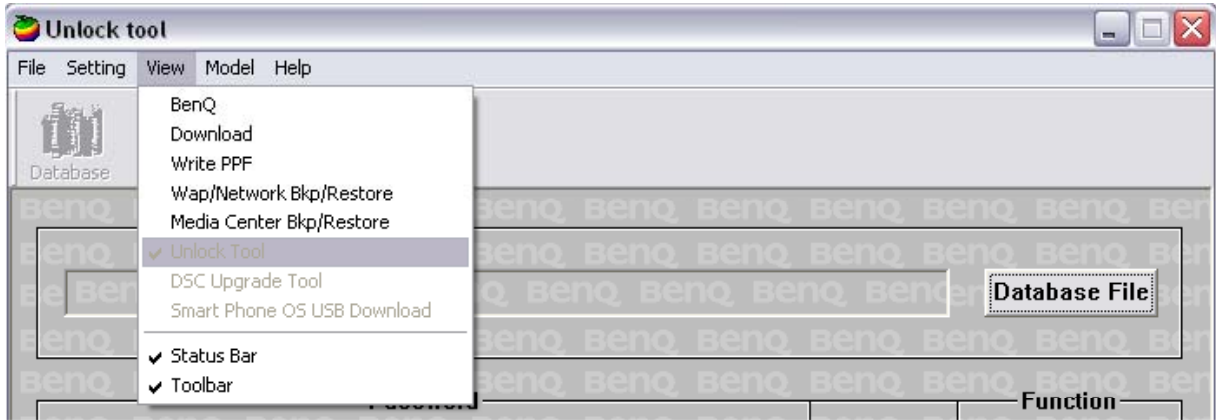


- Connect mobile phone with data cable. Phone must be switched on.
- Click to “Backup” button to start the transfer the settings into the selected file.
- Click to “Restore” button to start the transfer from selected file into handset.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 28 of 37

## 8. Unlock Tool

- Select Unlock tool function (View – Unlock Tool):

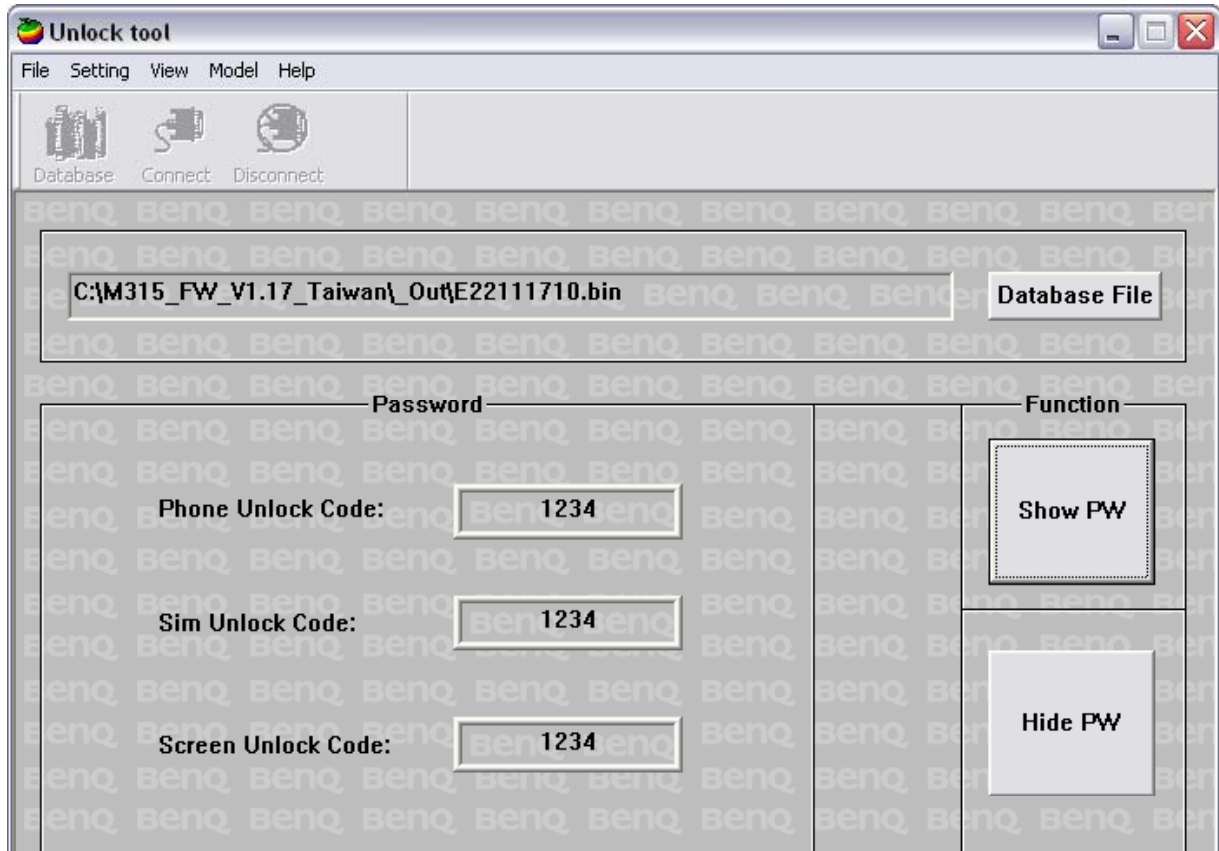


Select Database File (example: E22111710.bin)



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 29 of 37

- Click to “Show PW” button to get the codes.
- Unlock the codes in the mobile phone menu.
- Click to “Hide PW” button to hide the codes.



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 30 of 37

## 14 International Mobile Equipment Identity, IMEI

The mobile equipment is uniquely identified by the International Mobile Equipment Identity, IMEI, which consists of 15 digits. Type approval granted to a type of mobile is allocated 6 digits. The final assembly code is used to identify the final assembly plant and is assigned with 2 digits. 6 digits have been allocated for the equipment serial number for manufacturer and the last digit is spare.

E61 series IMEI label is accessible by removing the battery.

Re – use of IMEI label is possible by using a hair – dryer to remove the IMEI label.

Date code is shown on IMEI label: Detailed description on how to read date code is given in Annex 2.

To display the IMEI number, exit code and SW/HW version, key: \* # 300 #

Code \*#301# activates self diagnosis.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 31 of 37

## 15 General Testing Information

### General Information

The technical instruction for testing GSM mobile phones is to ensure the best repair quality.

### Validity

This procedure is to apply for all from BenQ mobile authorized level 2 up to 3 workshops.

### Procedure

All following checks and measurements have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

### Get delivery:

- Ensure that every required information like fault description, customer data a.s.o. is available.
- Ensure that the packing of the defective items is according to packing requirements.
- Ensure that there is a description available, how to unpack the defective items and what to do with them.

### Enter data into your database:

(Depends on your application system)

- Ensure that every data, which is required for the IRIS-Reporting is available in your database.
- Ensure that there is a description available for the employees how to enter the data.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 32 of 37



**Incoming check and check after assembling:**

**!! Verify the customers fault description!!**

- After a successful verification pass the defective item to the responsible troubleshooting group.
- If the fault description can not be verified, perform additional tests to save time and to improve repair quality.
  - Switch on the device and enter PIN code if necessary unblock phone.
  - Check the function of all **keys** including **side keys**.
  - Check the **display** for error in line and row, and for illumination.
  - Check the **ringer/loudspeaker** acoustics by individual validation.
  - Perform a **GSM Test** as described on page 36.

**Check the storage capability:**

- Check internal resistance and capacity of the battery.
- Check battery charging capability of the mobile phone.
- Check charging capability of the power supply.
- Check current consumption of the mobile phone in different mode.

**Visual inspection:**

- Check the entire board for liquid damages.
- Check the entire board for electrical damages.
- Check the housing of the mobile phone for damages.

**SW update:**

- Carry out a software update and data reset according to the master tables and operator/customer requirements.

**Repairs:**

**The disassembling as well as the assembling of a mobile phone has to be carried out by considering the rules mentioned in the dedicated manuals. If special equipment is required the service partner has to use it and to ensure the correct function of the tools.**

**If components and especially soldered components have to be replaced all rules mentioned in dedicated manuals or additional information e.g. service information have to be considered**

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 33 of 37

GSM Test:

**With the availability of the GRT Test /Alignment software, this tool has to be used to perform the outgoing test!**

>Connect the mobile/board via internal antenna (antenna coupler) and external antenna (car cradle/universal antenna clip) to a GSM tester

>Use a Test SIM

For Triple Band phones use a separate test case, if the test software allows only one handover.

Skip the GSM Band test cases if not performed by the mobile phone

Example:                    1. Test file                    Band 1 = GSM900 / Band 2 = GSM1800  
                                   2. Test file                    Band 1 = GSM1900

Internal Antenna				
Test case		Parameter	Measurements	Limits
1	Location Update	<ul style="list-style-type: none"> <li>• GSM Band 1</li> <li>• BS Power = -55 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Display check</li> </ul>	<ul style="list-style-type: none"> <li>• individual check</li> </ul>
2	Call from BS	<ul style="list-style-type: none"> <li>• low TCH</li> <li>• highest PCL</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Ringer/Loudspeaker check</li> </ul>	<ul style="list-style-type: none"> <li>• individual check</li> </ul>
3	TX GSM Band 1	<ul style="list-style-type: none"> <li>• low TCH</li> <li>• highest PCL</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Frequency Error</li> <li>• Phase Error RMS</li> <li>• Phase Error Peak</li> <li>• Average Power</li> <li>• Power Time Template</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
4	Handover to GSM Band 2 Including Handover Check			
5	TX GSM Band 2	<ul style="list-style-type: none"> <li>• low TCH</li> <li>• highest PCL0</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Frequency Error</li> <li>• Phase Error RMS</li> <li>• Phase Error Peak</li> <li>• Average Power</li> <li>• Power Time Template</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
6	Call release from BS			

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 34 of 37

External Antenna				
7	Call from MS	<ul style="list-style-type: none"> <li>• GSM900</li> <li>• high TCH</li> <li>• second highest PCL</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Keyboard check</li> </ul>	<ul style="list-style-type: none"> <li>• individual check</li> </ul>
8	TX GSM Band 1	<ul style="list-style-type: none"> <li>• high TCH</li> <li>• second highest PCL</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Frequency Error</li> <li>• Phase Error RMS</li> <li>• Phase Error Peak</li> <li>• Average Power</li> <li>• Power Time Template</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
9	RX GSM Band 1	<ul style="list-style-type: none"> <li>• high TCH</li> <li>• BS Power = -102 dBm</li> <li>• 50 Frames</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• RX Level</li> <li>• RX Qual</li> <li>• BER Class Ib</li> <li>• BER Class II</li> <li>• BER Erased Frames</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
10	Handover to GSM Band 2 Including Handover Check			
11	TX GSM Band 2	<ul style="list-style-type: none"> <li>• high TCH</li> <li>• second highest PCL</li> <li>• BS Power = -75 dBm</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• Frequency Error</li> <li>• Phase Error RMS</li> <li>• Phase Error Peak</li> <li>• Average Power</li> <li>• Power Time Template</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
12	RX GSM Band2	<ul style="list-style-type: none"> <li>• high TCH</li> <li>• BS Power = -102 dBm</li> <li>• 50 Frames</li> <li>• middle BCCH</li> </ul>	<ul style="list-style-type: none"> <li>• RX Level</li> <li>• RX Qual</li> <li>• BER Class Ib</li> <li>• BER Class II</li> <li>• BER Erased Frames</li> </ul>	<ul style="list-style-type: none"> <li>• GSM Spec.</li> </ul>
13	Call release from MS			

### Final Inspection:

The final inspection contains:

- 1) A 100% network test (location update, and set up call).
- 2) Refer to point 3.3.
- 3) A random sample checks of:
  - Data reset (if required)
  - Optical appearance
  - complete function
- 4) Check if PIN-Code is activated (delete the PIN-Code if necessary).

Basis is the international standard of **DIN ISO 2859**.

Use Normal Sample Plan Level II and the Quality Border 0,4 for LSO.

**Remark:** All sample checks must be documented.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 35 of 37

## Annex 1

### Test SIM Card

There are two different “Test SIM Cards” in use:

1) Test SIM Card from the company “**ORGA**”

Pin 1 number: 0000  
PUK 1 : 12345678

Pin 2 number: 0000  
PUK 2 : 23456789

2) Test SIM Card from the company “**T-D1**”

Pin 1 number: 1234  
PUK : 76543210

Pin 2 number: 5678  
PUK 2 : 98765432

Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 36 of 37

## Annex 2

### Device Date Code overview

GSN rule:

(ex: GS11500001TG0)

GS      1      9      5      00001      TG0  
Big class   Date   Month   Year   S/N   Factory

Code	Meaning	Content
D	Date	1-9, A=10, B=11, C=12, D=13, E=14, F=15, G=16, H=17, J=18, K=19, L=20, M=21, N=22, P=23, R=24, S=25, T=26, V=27, W=28, X=29, Y=30, Z=31 (Don't use: 0, I, O, Q, U)
M	Month	1=Jan, 2=Feb, 3=Mar, 4=Apr, 5=May, 6=Jun, 7=Jul, 8=Aug, 9=Sep, A=Oct., B=Nov, C=Dec
Y	Year	Last digit of Year (Christian era) ex. Year 2004 → "4"

Based on the definition above, GSC55... below means 2005/05/12.



Technical Documentation	Release 1.0
TD_Repair_L1-L2_S81_R1.0.pdf	Page 37 of 37